



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Su, *et al.* Docket No.: TSM03-0150
Serial No.: 10/675,862 Art Unit: 2823
Filed: September 30, 2003 Examiner: Fernando L. Toledo
For: Apparatus And Method For Manufacturing A Semiconductor Wafer With
Reduced Delamination And Peeling

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

Dear Sir:

The following amendments and remarks are presented in response to the Examiner's
Office Action mailed November 9, 2005. Please amend the above-referenced application as
follows.